


1732

TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT (Under 37 CFR 1.97(b) or 1.97(c))			Docket No. SKI.007D	
In Re Application Of: Hiroyuki Nishi et al.			<i>#7</i> <i>9-10-03</i>	
Serial No. 09/893,455	Filing Date June 29, 2001		Examiner A. Ortiz	Group Art Unit 1732
Title: TRANSFER MOLDING METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICES (As Amended)				
<div style="text-align: center;">Address to: Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450</div> <div style="text-align: right;">RECEIVED SEP 09 2003 TC 1700</div> <div style="text-align: center;">37 CFR 1.97(b)</div> <p>1. <input type="checkbox"/> The Information Disclosure Statement submitted herewith is being filed within three months of the filing of a national application other than a continued prosecution application under 37 CFR 1.53(d); within three months of the date of entry of the national stage as set forth in 37 CFR 1.491 in an international application; before the mailing of a first Office Action on the merits, or before the mailing of a first Office Action after the filing of a request for continued examination under 37 CFR 1.114.</p> <div style="text-align: center;">37 CFR 1.97(c)</div> <p>2. <input checked="" type="checkbox"/> The Information Disclosure Statement submitted herewith is being filed after the period specified in 37 CFR 1.97(b), provided that the Information Disclosure Statement is filed before the mailing date of a Final Action under 37 CFR 1.113, a Notice of Allowance under 37 CFR 1.311, or an Action that otherwise closes prosecution in the application, and is accompanied by one of:</p> <p style="padding-left: 40px;"><input checked="" type="checkbox"/> the statement specified in 37 CFR 1.97(e);</p> <p style="text-align: center;">OR</p> <p style="padding-left: 40px;"><input type="checkbox"/> the fee set forth in 37 CFR 1.17(p).</p>				

TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT**(Under 37 CFR 1.97(b) or 1.97(c))**

Docket No.

SKI.007D

In Re Application: **Hiroyuki Nishi et al.**

SEP 05 2003

Serial No.

09/893,455

Filing Date

June 29, 2001

Examiner

A. Ortiz

Group Art Unit

1732

TRANSFER MOLDING METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICES

(As Amended)

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(Only complete if Applicant elects to pay the fee set forth in 37 CFR 1.17(p))

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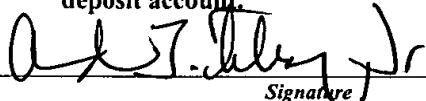
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Signature

Dated: September 5, 2003

ANDREW J. TELESZ, JR.

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RESTON, VA 20191

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CC:

**STATEMENT UNDER 37 CFR 1.97(e) ACCOMPANYING
INFORMATION DISCLOSURE STATEMENT**

Docket No.
SKI.007D

In Re Application Of: **Hiroyuki Nishi et al.**

SEP 05 2003

Serial No.

09/893,455

Filing Date

June 29, 2001

Examiner

A. Ortiz

Group Art Unit

1732

Invention: **TRANSFER MOLDING METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICES**
(As Amended)

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TO THE COMMISSIONER FOR PATENTS:

This is a statement under the provisions of 37 CFR 1.97(e) in the above-identified application.

Check applicable statement herebelow:

Statement Under 37 CFR 1.97(e)(1)

- ☒ Each item of information contained in the accompanying Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the Information Disclosure Statement.

Statement Under 37 CFR 1.97(e)(2)

- ☐ No item of information contained in the accompanying Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the undersigned person, after making reasonable inquiry, no item of information contained in the accompanying Information Disclosure Statement was known to any individual designated in 37 CFR 1.56(c) more than three months prior to the filing of the Information Disclosure Statement.


Signature

Dated: September 5, 2003

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